

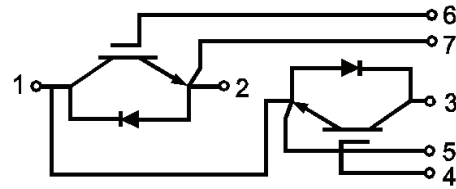


# GT150HF120T2VH

## IGBT Module

### Features:

- Field Stop Trench Gate IGBT
- Short Circuit Rated >10 $\mu$ s
- Low Saturation Voltage
- Low Switching Loss
- 100% RBSOA Tested (2 $\times$ I<sub>C</sub>)
- Low Stray Inductance
- Lead Free, Compliant with RoHS Requirement



### Applications:

- Welding
- HEV Inverter
- Industrial Motor Drives
- UPS

### Maximum Rated Values of IGBT (T<sub>C</sub>=25 $^{\circ}$ C unless otherwise specified)

V <sub>CES</sub>	Collector-Emitter Blocking Voltage		1200	V
V <sub>GES</sub>	Gate-Emitter Voltage		$\pm$ 20	V
I <sub>C</sub>	Continuous Collector Current	T <sub>C</sub> = 100 $^{\circ}$ C	150	A
		T <sub>C</sub> = 25 $^{\circ}$ C	265	A
I <sub>CM</sub>	Repetitive Peak Collector Current	T <sub>J</sub> = 175 $^{\circ}$ C	300	A
t <sub>SC</sub>	Short Circuit Withstand Time		>10	$\mu$ s
P <sub>D</sub>	Maximum Power Dissipation per leg	T <sub>C</sub> = 25 $^{\circ}$ C T <sub>Jmax</sub> = 175 $^{\circ}$ C	1040	W



## Electrical Characteristics of IGBT ( $T_C=25^\circ\text{C}$ unless otherwise specified)

### Static Characteristics

Symbol	Description	Conditions	Min.	Typ.	Max.	Units
$V_{GE(th)}$	Gate-Emitter Threshold Voltage	$I_C=4\text{mA}$ , $V_{CE}=V_{GE}$	5.0	5.8	6.8	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	$I_C=150\text{A}$ , $V_{GE}=15\text{V}$	$T_J=25^\circ\text{C}$	1.95	2.25	V
			$T_J=125^\circ\text{C}$	2.30		
$I_{CES}$	Collector-Emitter Leakage Current	$V_{GE}=0\text{V}$ , $V_{CE}=V_{CES}$ , $T_J=25^\circ\text{C}$			1	mA
$I_{GES}$	Gate-Emitter Leakage Current	$V_{GE}=\pm 20\text{V}$ , $V_{CE}=0\text{V}$ , $T_J=25^\circ\text{C}$			400	nA
$C_{ies}$	Input Capacitance	$V_{CE}=25\text{V}$ , $V_{GE}=0\text{V}$ , $f=100\text{kHz}$		13.80		nF
$C_{oes}$	Output Capacitance			0.90		
$C_{res}$	Reverse Transfer Capacitance			0.12		

### Switching Characteristics

$t_{d(on)}$	Turn-on Delay Time	$V_{CC}=600\text{V}$ , $I_C=150\text{A}$ , $R_{Gon}=4.7\Omega$ , $V_{GE}=\pm 15\text{V}$ , Inductive Load	$T_J=25^\circ\text{C}$	320	ns
			$T_J=125^\circ\text{C}$	360	
$t_r$	Rise Time	$V_{CC}=600\text{V}$ , $I_C=150\text{A}$ , $R_{Gon}=4.7\Omega$ , $V_{GE}=\pm 15\text{V}$ , Inductive Load	$T_J=25^\circ\text{C}$	105	ns
			$T_J=125^\circ\text{C}$	117	
$t_{d(off)}$	Turn-off Delay Time	$V_{CC}=600\text{V}$ , $I_C=150\text{A}$ , $R_{Goff}=4.7\Omega$ , $V_{GE}=\pm 15\text{V}$ , Inductive Load	$T_J=25^\circ\text{C}$	238	ns
			$T_J=125^\circ\text{C}$	244	
$t_f$	Fall Time	$V_{CC}=600\text{V}$ , $I_C=150\text{A}$ , $R_{Goff}=4.7\Omega$ , $V_{GE}=\pm 15\text{V}$ , Inductive Load	$T_J=25^\circ\text{C}$	164	ns
			$T_J=125^\circ\text{C}$	304	
$E_{on}$	Turn-on Switching Loss	$V_{CC}=600\text{V}$ , $I_C=150\text{A}$ , $R_{Gon}=4.7\Omega$ , $V_{GE}=\pm 15\text{V}$ , $di/dt=1090\text{A}/\mu\text{s}$ ( $T_J=125^\circ\text{C}$ ), Inductive Load	$T_J=25^\circ\text{C}$	9.3	mJ
			$T_J=125^\circ\text{C}$	14.7	
$E_{off}$	Turn-off Switching Loss	$V_{CC}=600\text{V}$ , $I_C=150\text{A}$ , $R_{Goff}=4.7\Omega$ , $V_{GE}=\pm 15\text{V}$ , $du/dt=5875\text{V}/\mu\text{s}$ ( $T_J=125^\circ\text{C}$ ), Inductive Load	$T_J=25^\circ\text{C}$	8.0	mJ
			$T_J=125^\circ\text{C}$	12.9	
$Q_g$	Total Gate Charge	$V_{GE}=+15\text{V} \dots -15\text{V}$	$T_J=25^\circ\text{C}$	658	nC
$R_{g \text{ internal}}$	Internal Gate Resistance		$T_J=25^\circ\text{C}$	5	$\Omega$
RBSOA	Reverse Bias Safe Operation Area	$I_C=400\text{A}$ , $V_{CC}=1050\text{V}$ , $V_p=1200\text{V}$ , $R_{Goff}=2\Omega$ , $V_{GE}=+15\text{V}$ to $0\text{V}$ , $T_J=150^\circ\text{C}$	Trapezoid		
SC Data	$V_{CC}=600\text{V}$ , $t_p=10\mu\text{s}$ , $V_{GE}=\pm 15\text{V}$ , $R_{Gon}=4.7\text{ohm}$ , $R_{Goff}=4.7\text{ohm}$ , $T_J=125^\circ\text{C}$		750		A
$R_{\theta JC}$	IGBT Thermal Resistance: Junction-To-Case			0.144	$^\circ\text{C}/\text{W}$



## Diode, Inverter

### Maximum Rated Values of Diode ( $T_C=25^\circ\text{C}$ unless otherwise specified)

$V_{RRM}$	Repetitive Peak Reverse Voltage	1200	V
$I_F$	Diode Continuous Forward Current	150	A
$I_{FM}$	Diode Maximum Forward Current	300	A

### Electrical Characteristics of Diode ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Description	Conditions	Min.	Typ.	Max.	Units	
$V_{FM}$	Forward Voltage	$I_F=150\text{A}$	$T_J=25^\circ\text{C}$	1.60		V	
			$T_J=125^\circ\text{C}$	1.70			
$t_{rr}$	Reverse Recovery Time	$I_F=150\text{A}$ , $-diF/dt=1413\text{A}/\mu\text{s}(T_J=125^\circ\text{C})$ , $V_{rr}=600\text{V}$ , $V_{GE}=-15\text{V}$	$T_J=25^\circ\text{C}$	335		ns	
			$T_J=125^\circ\text{C}$	567			
$I_{rr}$	Peak Reverse Recovery Current		$T_J=25^\circ\text{C}$	68		A	
			$T_J=125^\circ\text{C}$	72			
$Q_{rr}$	Reverse Recovery Charge		$T_J=25^\circ\text{C}$	10		$\mu\text{C}$	
			$T_J=125^\circ\text{C}$	16			
$E_{rec}$	Reverse Recovery Energy		$T_J=25^\circ\text{C}$	4.1		mJ	
			$T_J=125^\circ\text{C}$	6.9			
$R_{\theta JC}$	Diode Thermal Resistance: Junction-to-Case					0.250	$^\circ\text{C}/\text{W}$



## Module

Symbol	Description	Min	Typ	Max	Unit
V <sub>iso</sub>	Isolation Voltage(All Terminals Shorted)	f=50Hz, 1minute	2500		V
L <sub>SCE</sub>	Stray Inductance Module		20		nH
T <sub>J</sub>	Maximum Junction Temperature			175	°C
T <sub>JOP</sub>	Maximum Operating Junction Temperature Range	-40		+150	°C
T <sub>stg</sub>	Storage Temperature	-40		+125	°C
CTI	Comparative Tracking Index	200			
R <sub>θCS</sub>	Case-To-Sink Thermally (Conductive Grease Applied)			0.03	°C/W
T	Power Terminals Screw:M6	3.0		5.0	N·m
T	Mounting Screw:M6	4.0		6.0	N·m
G	Weight		300		g

## Ordering Information Table

Device code	G	T	150	HF	120	T2V	H
	①	②	③	④	⑤	⑥	⑦

- ①-IGBT Module
- ②-Trench, Low Switching Losses IGBT
- ③-Rated Current (150=150A)
- ④-Circuit Configuration: HF (Half Bridge)
- ⑤-Rated Voltage (120=1200V)
- ⑥-Package Type
- ⑦-Test Level (Pass the Important Reliability Test-Industrial Grade)

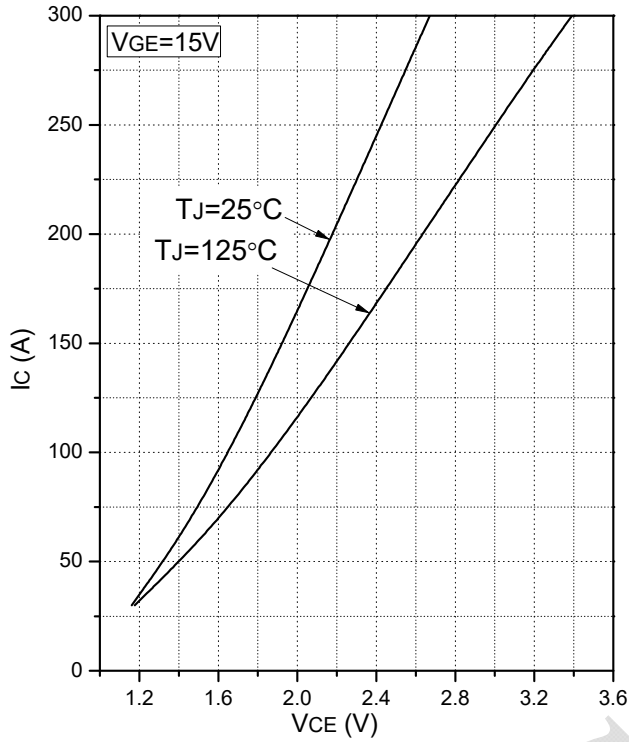


Fig.1 Typical Saturation Voltage Characteristics

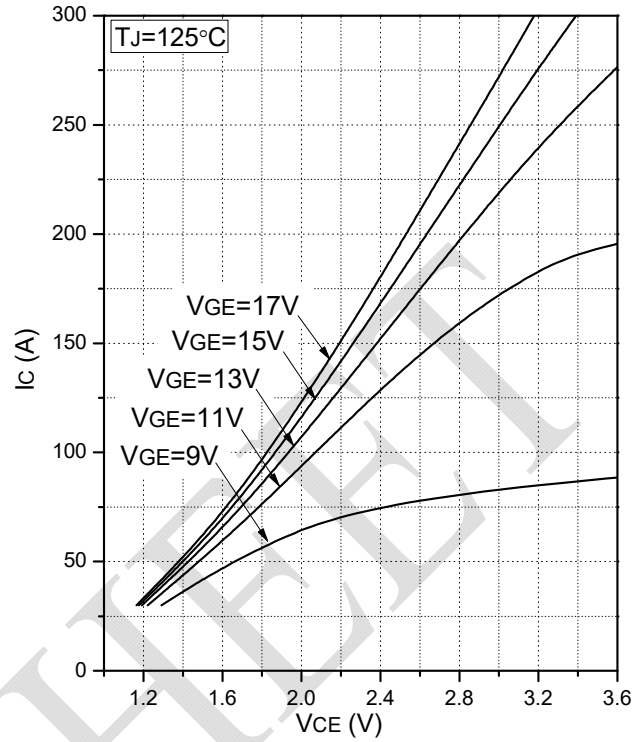


Fig.2 Typical Output Characteristics

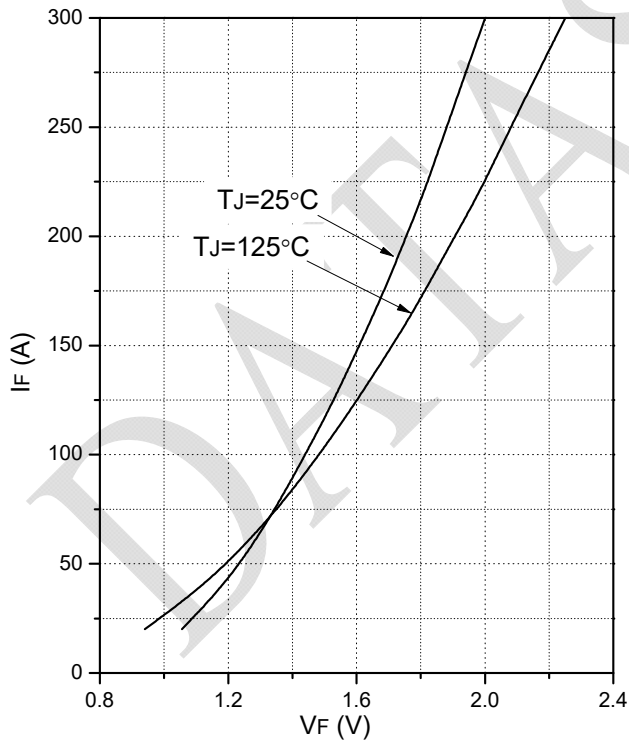


Fig.3 Forward Characteristics of Diode

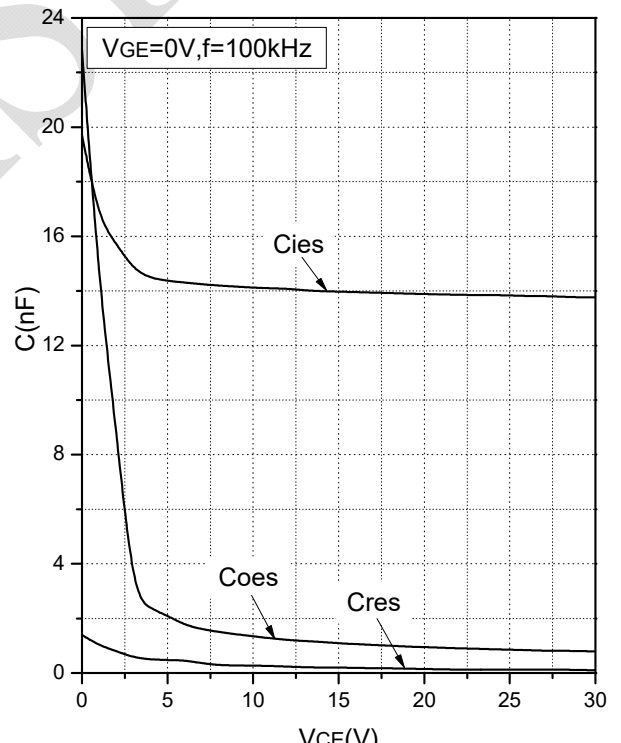


Fig.4 Capacitance Characteristics

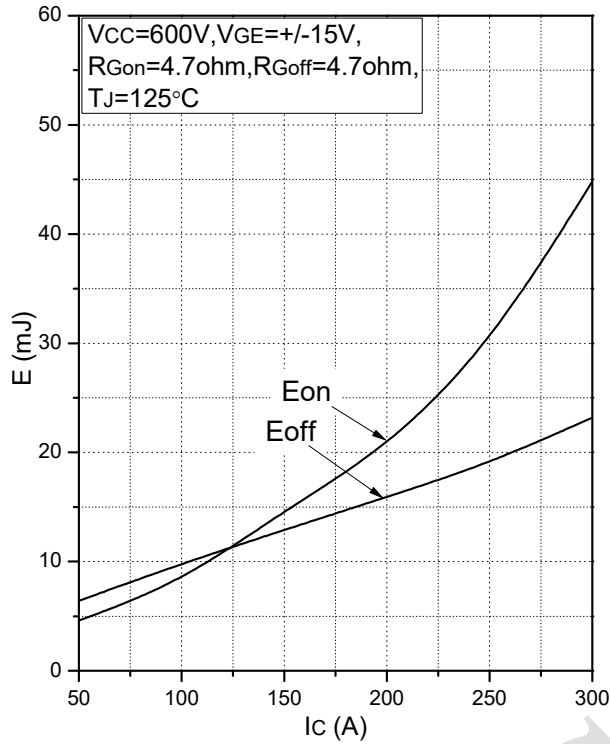


Fig.5 Typical Switching Loss vs. Collector Current

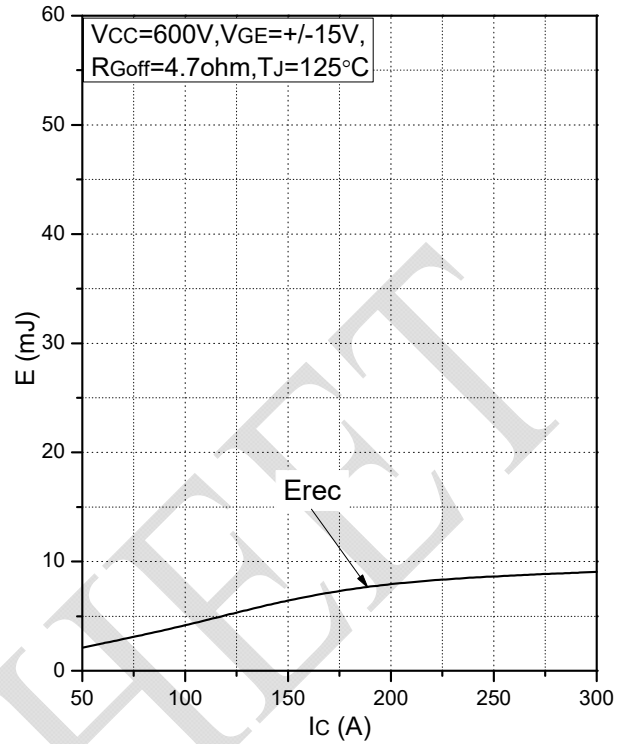


Fig.6 Typical Switching Loss vs. Forward Current

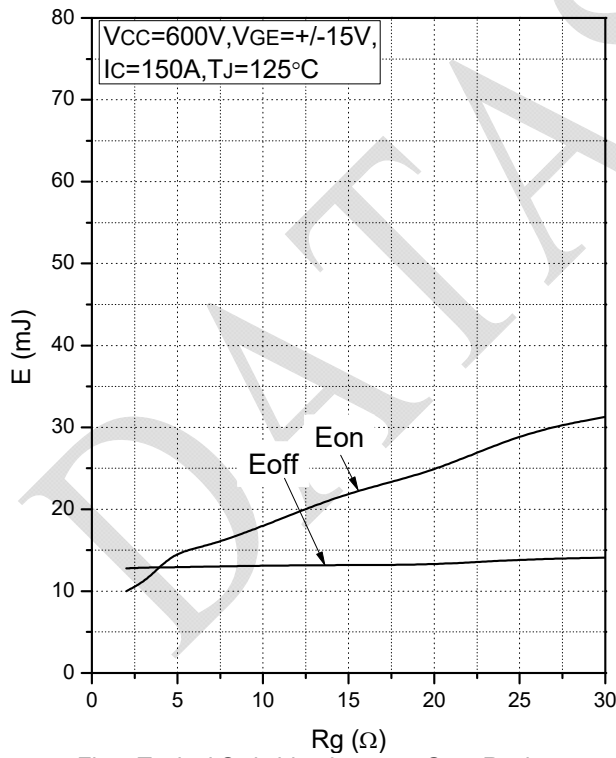


Fig.7 Typical Switching Loss vs. Gate Resistance

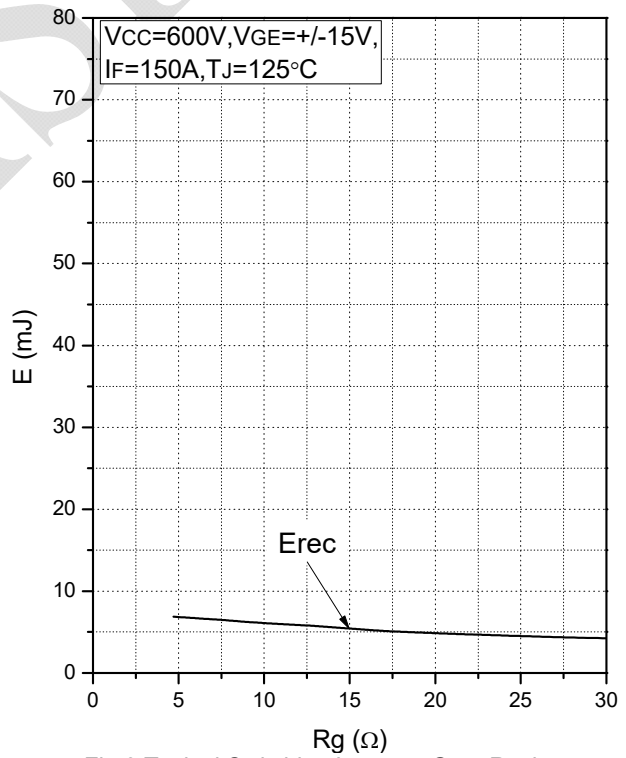


Fig.8 Typical Switching Loss vs. Gate Resistance

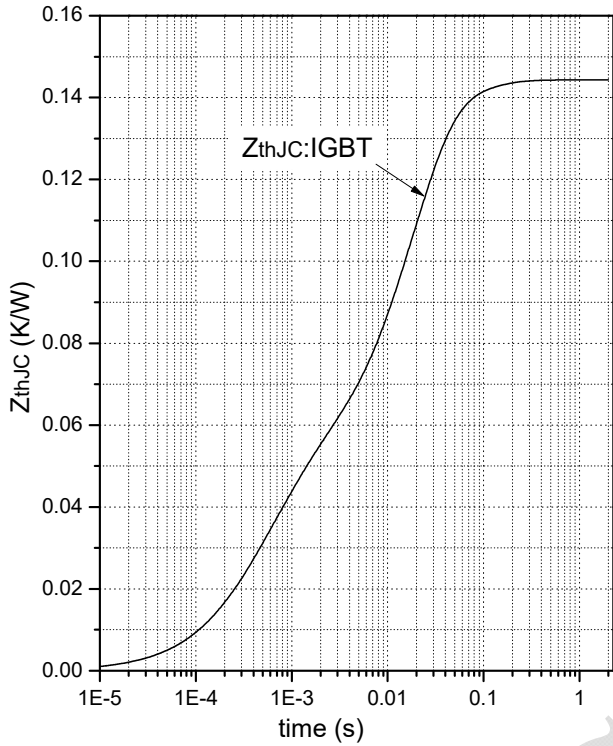


Fig.9 Transient Thermal Impedance (IGBT)

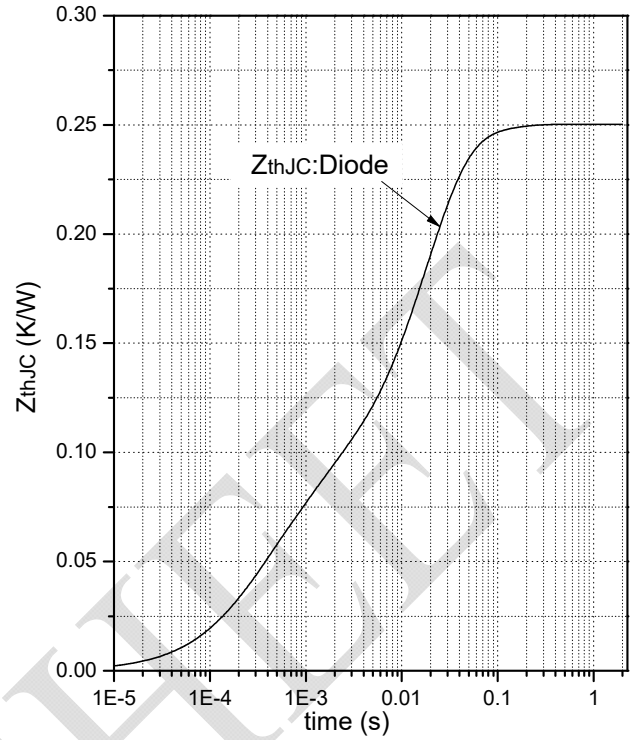


Fig.10 Transient Thermal Impedance (Diode)

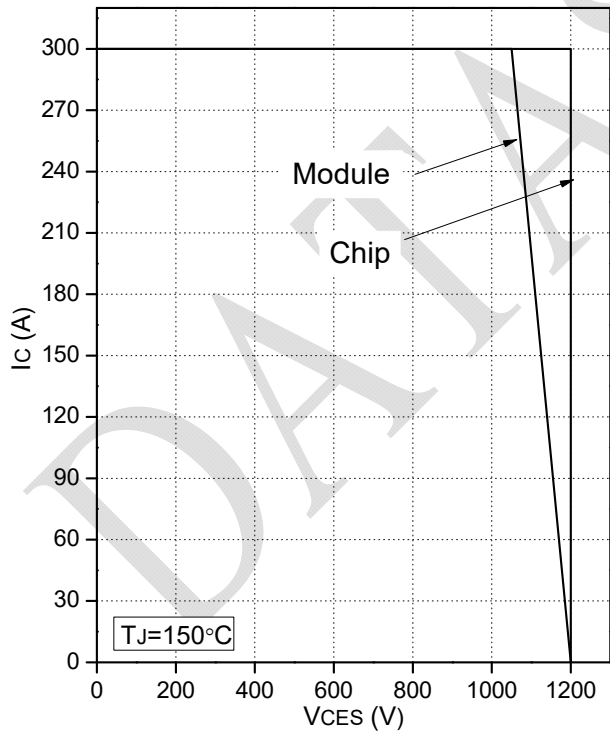


Fig.11 Reverse Bias Safe Operation Area (RBSOA)







Date	Revision	Notes
03/04/2022	A	Final Version

## Announcements

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The datasheet with “REV.” + “Arabic numerals” is based on engineering data for initial reference purpose only.

The released datasheet would be issued with “REV.” + “alphabet characters”.

DATA SHEET